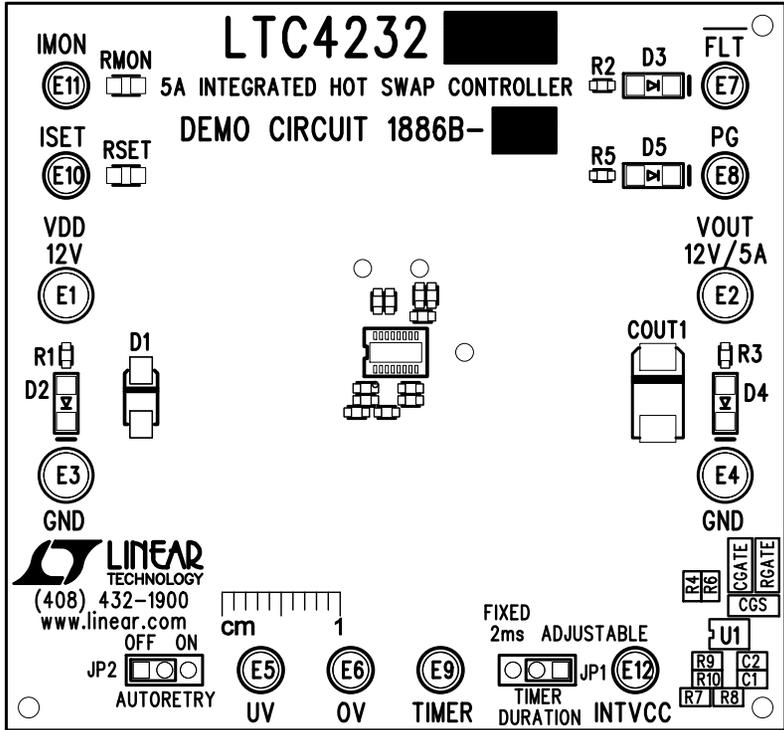


REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
-	2	REBUILD W CHANGE	VLADIMIR O.	06-11-14



NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEG. C.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. MARK EACH SUFFIX AND ASSEMBLY TYPE IN THE WHITE BLOCK AREAS WITH BLACK PERMANENT MARKER AS SHOWN IN TABLE BELOW

ASSY	U1	SUFFIX
A	LTC4232IDHC	
B	LTC4232IDHC-1	-1

APPROVALS				1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 www.linear.com LTC CONFIDENTIAL - FOR CUSTOMER USE ONLY	
PCB DES.	KIM T.	TITLE: TOP ASSEMBLY DRAWING			
APP ENG.	VLADIMIR O.				
		5A INTEGRATED HOT SWAP CONTROLLER			
		SIZE	IC NO.	LTC4232IDHC/-1	REV.
		N/A		DEMO CIRCUIT 1886B	2
SCALE = NONE		FILENAME:		DC1886B-2.PCB	SHT 1 OF 1